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PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date	
ATSUSHI OGASAWARA	08/05/2013	
KOJI ITO	08/05/2013	
KAZUHIKO ITO	08/05/2013	
KOYA MUYARI	08/05/2013	

RECEIVING PARTY DATA

Name:	SHINDENGEN ELECTRIC MANUFACTURING CO., LTD	
Street Address:	2-1, OHTEMACHI 2-CHOME, CHIYODA-KU	
City:	ТОКУО	
State/Country:	JAPAN	
Postal Code:	100-0004	

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	13980435

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ATTORNEY DOCKET NUMBER:	4592-035	
NAME OF SUBMITTER:	BENJAMIN J. HAUPTMAN	
Signature:	/Benjamin J. Hauptman/	
Date:	12/12/2013	

Total Attachments: 1

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PATENT REEL: 031771 FRAME: 0530 340.00 13980435

Docket No.: 4592-035

ASSIGNMENT

In consideration of the premises ar	d other good an	d valuable consideration	n in hand paid	, the receipt and	sufficiency of
which is hereby acknowledged, the undersig	ned,				

1) Atsushi OGASAWARA

3) Kazuhiko ITO

2) Koji ITO

4) Koya MUYARI

who has made a certain new and useful invention, hereby sells, assigns and transfers unto

SHINDENGEN ELECTRIC MANUFACTURING CO., LTD. having a place of business at 2-1,

Ohtemachi 2-chome, Chiyoda-ku, Tokyo 100-0004 Japan

its successors and assigns (hereinafter designated "ASSIGNEE") the entire right, title and interest for the United States of America as defined in 35 U.S.C. 100 in the invention entitled

METHOD OF MANUFACTURING SEMICONDUCTOR DEVICE AND SEMICONDUCTOR DEVICE			
(a)	for which an application for United States Letters Patent was filed onJuly 18, 2013 identified by United States Patent Application No13/980.435; or	_, and	
(b)	for which an application for United States Letters Patent was executed on,		
	he undersigned hereby authorizes and requests the United States Commissioner of Patents and Trademarks to issue an nited States Letters Patent which may be granted therefore and any and all extensions, divisions, reissues, continuation	-	

continuations-in-part thereof, and the right to all benefits under the International Convention for the Protection of Industrial Property to the said ASSIGNEE, for its interest as ASSIGNEE, its successors, assigns and legal representatives; the undersigned agrees that the attorneys of record in said application shall hereafter act on behalf of said ASSIGNEE;

AND the undersigned hereby agrees to transfer a like interest, and to render all necessary assistance in making application for and obtaining original, divisional, reissued or extended Letters Patent of the United States, upon request of the said ASSIGNEE, its successors, assigns and legal representatives, and without further remuneration, in and to any improvements, and applications for patent based thereon, growing out of or related to the said invention; and to execute any papers by the said ASSIGNEE, its successors, assigns and legal representatives, deemed essential to ASSIGNEE's full protection and title in and to the invention hereby transferred.

SIGNED on the date indicated aside my signature:

1) Ateuchi Ogasawora	August 05, 20/3
Name: Atsushi OGASAWARA	Date:
2) <u>Kojć ITO</u> Name: Koji ITO	<u>August 0,5.2013</u> Date:
Name: Koji ITO	
3) Kazuhiko Ito	August 05, 2013 Date:
Name: Kazuhiko ITO	Date:
4) <u>Roga Muyari</u> Name: Koya MUYARI	august 05, 2013
Name: Koya MUYARI	Date:

PATENT REEL: 031771 FRAME: 0531

RECORDED: 12/12/2013